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PRODUCT SPECIFICATION

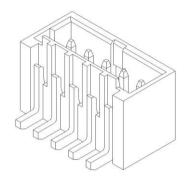
1.50MM PITCH, WIRE-TO-BOARD SMT HEADER AND RECEPTACLE

1.0 SCOPE

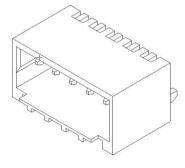
This specification covers the performance requirement for a 1.50mm pitch, Wire-To-Board Header and Receptacle System.

2.0 PRODUCT DESCRIPTION

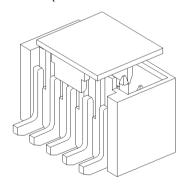
- 2.1 Products covered by this specification are for series number
 - 1. 78047 (Vertical SMT Header)
 - 2. 78048 (Right-Angle SMT Header)
 - 3. 87439 (Receptacle housing)
 - 4. 87421 (Receptacle Crimp Terminal)
- 2.2 For dimensions, materials, platings and markings, refer to the appropriate Sales drawings.



78047 (Vertical SMT Header)



78048 (Right-Angle SMT Header)



78047 (Vertical SMT Header with CAP)

TENTATIVE RELEASE:

THIS SPECIFICATION IS BASED ON DESIGN OBJECTIVES AND IS STRICTLY TENTATIVE. PRELIMINARY TEST DATA MAY EXIST, BUT THIS SPECIFICATION IS SUBJECTED TO CHANGE BASED ON THE RESULTS OF ADDITIONAL TESTING AND EVALUATION.

REVISION:	ECR/ECN INFORMATION: EC No: J2016-0573 DATE: 2015/12/09	1.50MM PI	TCH, WIRE-TO-BO ER AND RECEPT		1 of 5
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPR(OVED BY:
PS-78047-001		AISHIKAWA 2015/12/09	KASAKAWA 2015/12/09	NUKITA	2015/12/09
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PRODUCT SPECIFICATION

3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

The following documents are part of this specification to the extent specified herewith. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence.

In the event of conflict between the requirements of this specification and reference documents, this specification shall take the precedence.

MIL-STD-202 Test Methods for Electrical and Electronic Component Parts.

Electrical Connector Test Procedure EIA Standards

MIL-STD-1344 Test methods of Electrical Connector

4.0 RATINGS

4.1 Voltage Rating : 250 VAC Maximum

4.2 Current Rating : 2.5A Maximum

4.3 Operating Temperature : -55°C to +105°C

5.0 PERFORMANCE

5.1 ELECTRICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
1	Contact Resistance	Measure Contact Resistance by 10mAmp DC, open circuit voltage 20mV. Per MIL-STD-1344A, Method 3004.1	20 mohms Maximum (Initial) 40 mohms Maximum (After 10X durability, mechanical and/ or environmental test)
2	Insulation Resistance	Measurement taken between adjacent contacts where 500 VDC is applied. Per MIL-STD-202F, Method 302)	1000 Megaohms minimum
3	Dielectric Strength	Receptacle subjected to 500 VAC rms for 1 minute between adjacent contacts Per MIL-STD-202F, Method 301)	No breakdown

3	EC No: J2016-0573 DATE: 2015/12/09	1.50MM PI SMT HEAD	2 of 5		
DOCUMENT NUMBER:		CREATED / REVISED BY:	CHECKED BY:	APPRO	OVED BY:
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PRODUCT SPECIFICATION

5.2 MECHANICAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
4.	Single Extraction Force	Gauge dimension is 0.37 ±0.005 Withdraw pin from gauge at a rate of 12.7mm per minute	30g Minimum (Initial) 25g Minimum (After 10X)
5.	Total Insertion Force	Insert connectors at a rate of 12.7mm per minute	2P 2.5KG Max 3P 3.0KG Max 4P 3.5KG Max 5P 4.0KG Max 6P 4.5KG Max 7P 5.0KG Max 8P 5.5KG Max 9P 5.5KG Max 10P 6.0KG Max 11P 6.0KG Max 12P 6.5KG Max 13P 6.5KG Max 14P 7.0KG Max
6.	Total Extraction Force	Withdraw connectors at a rate of 12.7mm per minute	2P 1.0-3.0KG 3P 1.0-3.5KG 4P 1.0-4.0KG 5P 1.0-4.5KG 6P 1.0-5.0KG 7P 1.0-5.0KG 8P 1.5-5.5KG 9P 1.5-5.5KG 10P 1.5-6.0KG 11P 1.5-6.0KG 12P 1.5-6.5KG 13P 1.5-6.5KG 14P 1.5-7.0KG

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5.2 MECHANICAL REQUIREMENTS (Continue)

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
7.	Total Extraction Force (After 10X durability, SMT preconditioning, and/or moisture resistance test)	Withdraw connectors at a rate of 12.7mm per minute	2P 0.6-2.5KG 3P 0.6-3.0KG 4P 0.6-3.5KG 5P 0.8-4.0KG 6P 0.8-4.5KG 7P 0.8-4.5KG 8P 1.0-5.0KG 9P 1.0-5.0KG 10P 1.0-5.5KG 11P 1.0-5.5KG 12P 1.0-6.0KG 13P 1.0-6.0KG 14P 1.0-7.0KG 15P 1.0-7.0KG
8.	Thermal Life (Mated Connectors)	Parts to be subjected to 105°C in a chamber for 168 hours.	Contacts resistance : 40 mohms Maximum Appearance : No damage
9.	Thermal Shock (Mated Connectors)	Parts to be subjected to 2 hours of -55°C and 2 hours of 105°C for 10 cycles.	Similar to Thermal Life
10.	Moisture Resistance (Mated Connectors)	Parts to be subjected to 85°C and 85% RH for a period of 168 hours	Similar to Thermal Life

5.3 ENVIRONMENTAL REQUIREMENTS

ITEM	DESCRIPTION	TEST CONDITION	REQUIREMENT
11	Solderability	Solder Time: 5+/-0.5 seconds Solder temperature: 260+/-5 deg.C	Soldered area should be 95% or more
12	Resistance to Soldering Heat	Refer to Section 7.0 for soldering profile	No damage in appearance of connector
13	Push-out force	Push header pin axially from housing at a rate of 12.7mm per minute	0.7KG Minimum after Reflow

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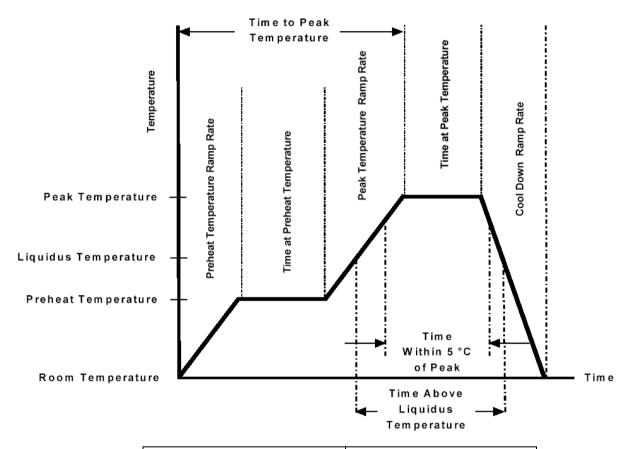
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6.0 PACKAGING

Product shall be packaged and protected against damage during handling, transportation and storage.

7.0 SOLDERING PROFILE



Description	Requirement
Average Ramp Rate	3°C/sec Max
Preheat Temperature	150°C Min to 200°C Max
Preheat Time	60 to 180 sec
Ramp to Peak	3°C/sec Max
Time over Liquidus (217°C)	60 to 150 sec
Peak Temperature	260 +0/-5°C
Time within 5°C of Peak	20 to 40 sec
Ramp - Cool Down	6°C/sec Max
Time 25°C to Peak	8 min Max

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